BB02-BZ-A :: 1.27mm X 1.27mm (0.05" X 0.05") BOX HEADER, THROUGH HOLE, DUAL ROW, RIGHT ANGLE - 06 TO 100 CONTACTS

SPECIFICATIONS:
- CURRENT RATING: 1 AMP
- INSULATOR RESISTANCE: 1000 MEGOHMS MIN.
- DIELECTRIC WITHSTANDING: AC 300 V
- CONTACT RESISTANCE: 20m OHMS MAX.
- OPERATING TEMPERATURE: -60°C TO +105°C
- CONTACT MATERIAL: BRASS
- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- PLATING: GOLD, TIN OR SELECTIVE OVER 30-50U” NICKEL
- SOLDERABILITY:
  - IR REFLOW: 280°C FOR 10 SEC
  - WAVE: 250°C FOR 5-10 SEC
  - MANUAL SOLDER: 380°C FOR 3-5 SEC

STANDARD PACKAGE: TRAY.

MATES WITH:
- PERFECT MATING PARTS: BB02-CM, BB02-CU
- OTHER MATING PARTS: BB02-CL, BB02-CN (4.40MM PROFILE ONLY)

RECOMMENDED PCB HOLE LAYOUT (TOLERANCE: ±0.05)

HOW TO ORDER

BB02 - BZXX1 - XA2 - 0000000

CONTACT PLATING OPTIONS:
- K = GOLD FLASH (STANDARD)
- A = 10U” GOLD ON CONTACT/GOLD FLASH ON TAIL
- B = 15U” GOLD ON CONTACT/GOLD FLASH ON TAIL
- C = 30U” GOLD ON CONTACT/GOLD FLASH ON TAIL
- T = BRIGHT TIN
- M = MATT TIN
- D = GOLD FLASH ON CONTACT/BRIGHT TIN ON TAIL
- E = 10U” GOLD ON CONTACT/BRIGHT TIN ON TAIL
- F = 15U” GOLD ON CONTACT/BRIGHT TIN ON TAIL
- G = 30U” GOLD ON CONTACT/BRIGHT TIN ON TAIL

Scale 4:1

File: 1 of 1

Drawing Number: 0000000

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Type: BB02-BZ

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